



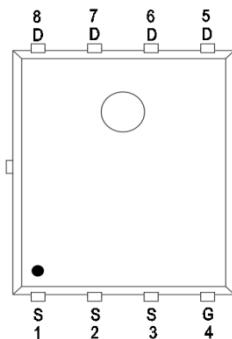
SSC8L420PN6

N-Channel Enhanced MOSFET

➤ Features

VDS	VGS	RDS(on) Typ.	ID
40V	$\pm 20V$	2.3m Ω @10V	116A
		3.0m Ω @4V5	

➤ Pin configuration

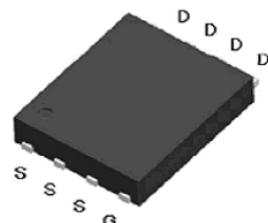


Top View

➤ Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDS(on) with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + $\Delta V_{ds} + R_g$ Tested!



PDFN5X6-8L

➤ Applications

- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

➤ Ordering Information

Device	Package	Shipping
SSC8L420PN6	PDFN5X6-8L	5000/Reel



Marking

➤ **Absolute Maximum Ratings (T_A=25°C unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	40	V
V _{GSS}	Gate-to-Source Voltage	±20	V
I _D	Continuous Drain Current ^d	T _C =25°C	116
		T _C =100°C	55
I _{DSM}	Continuous Drain Current ^a	T _A =25°C	36
		T _A =70°C	25
I _{DM}	Pulsed Drain Current ^b	464	A
P _D	Power Dissipation ^c	T _C =25°C	50
		T _C =100°C	20
P _{DSM}	Power Dissipation ^a	T _A =25°C	5.2
		T _A =70°C	3.3
I _{AS}	Avalanche Current ^b L=0.5mH Single Pulse	37	A
E _{AS}	Avalanche Energy ^b L=0.5mH Single Pulse	342	mJ
T _J	Operation junction temperature	-55~150	°C
T _{STG}	Storage temperature range	-55~150	

➤ **Thermal Resistance Ratings(T_A=25°C unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
R _{θJA}	Junction-to-Ambient Thermal Resistance ^a	20	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	2.4	

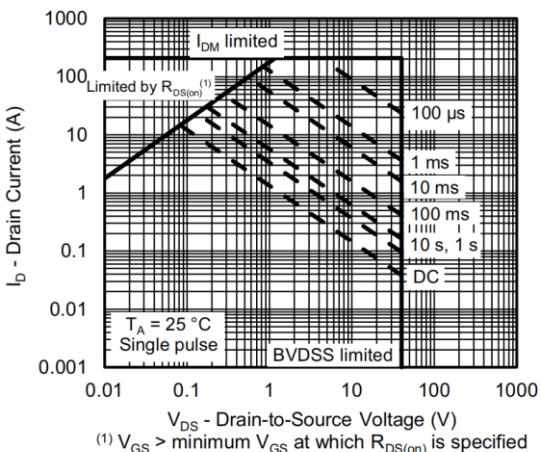
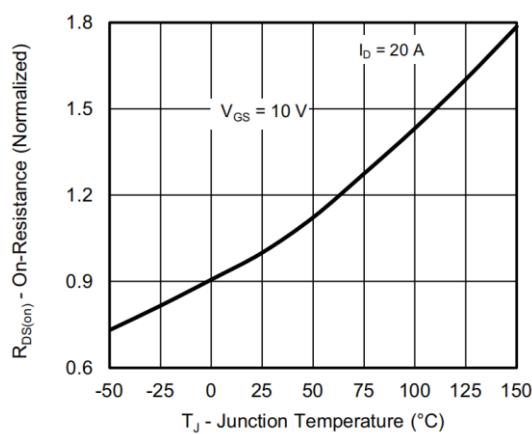
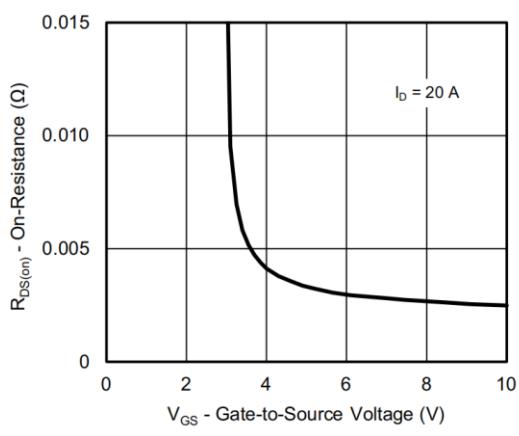
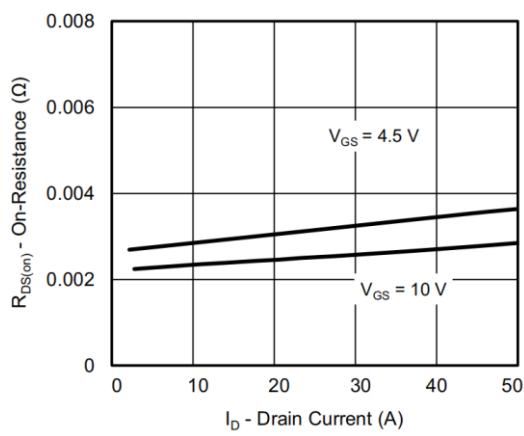
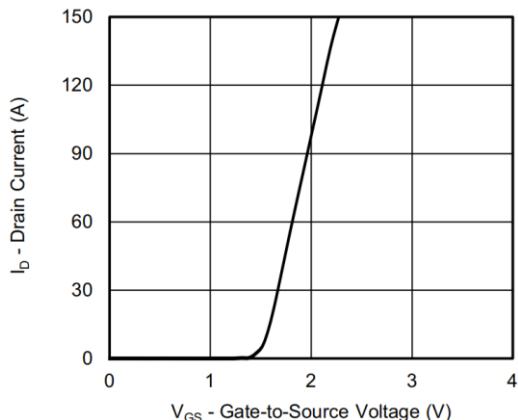
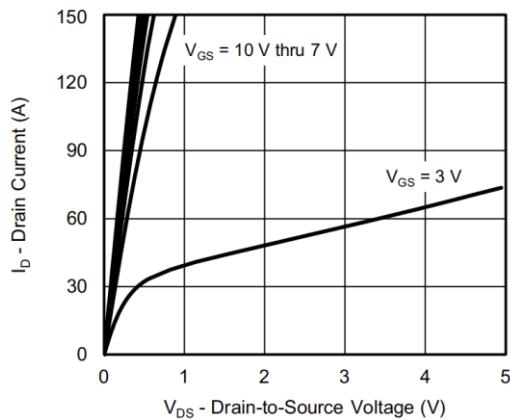
Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user specific board design. The power dissipation is based on the t ≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

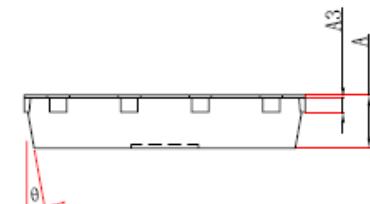
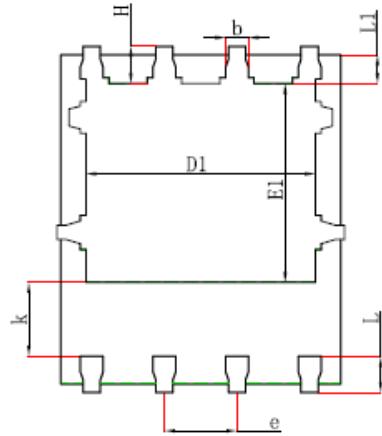
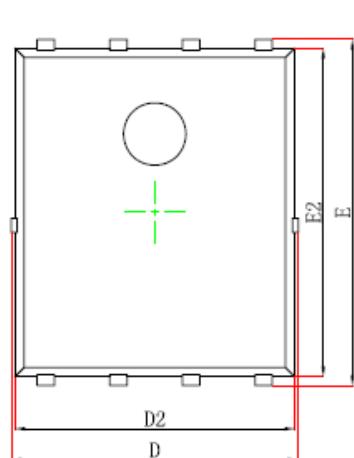
➤ Electronics Characteristics($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$VGS=0V, ID=250\mu A$	40			V
$V_{GS(th)}$	Gate Threshold Voltage	$VDS=VGS, ID=250\mu A$	1	1.4	2.0	V
$R_{DS(on)}$	Drain-Source On-Resistance	$VGS=10V, ID=20A$		2.3	3.0	$m\Omega$
		$VGS=4.5V, ID=10A$		3.0	4.0	
I_{DSS}	Zero Gate Voltage Drain Current	$VDS=40V, VGS=0V$			1	μA
I_{GSS}	Gate-Source leak current	$VGS=\pm 20V, VDS=0V$			± 150	nA
G_{FS}	Transconductance	$VDS=5V, ID=20A$		43		S
V_{SD}	Forward Voltage	$VGS=0V, IS=10A$		0.73	1.3	V
R_g	Gate Resistance	$VDS=0V, f=1MHz$		0.75		Ω
C_{iss}	Input Capacitance	$VDS=20V, VGS=0V, f=1MHz$		2747		pF
C_{oss}	Output Capacitance			680		
C_{rss}	Reverse Capacitance			62		
$T_{D(ON)}$	Turn-on delay time	$VGS=10V, RL=1\Omega$ $VDS=20V, RG=3\Omega$		10		ns
T_r	Rise time			3		
$T_{D(OFF)}$	Turn-off delay time			34		
T_f	Fall time			2.9		
Q_G	Total Gate Charge	$VGS=10V, VDS=20V$ $ID=20A$		57		nC
Q_{GS}	Gate Source Charge			7		
Q_{GD}	Gate Drain Charge			12		
T_{rr}	Diode Recovery Time	$IF=20A, di/dt=500A/us$		14		ns
Q_{rr}	Diode Recovery Charge	$IF=20A, di/dt=500A/us$		43		nC

➤ **Typical Characteristics**($T_A=25^\circ\text{C}$ unless otherwise noted)



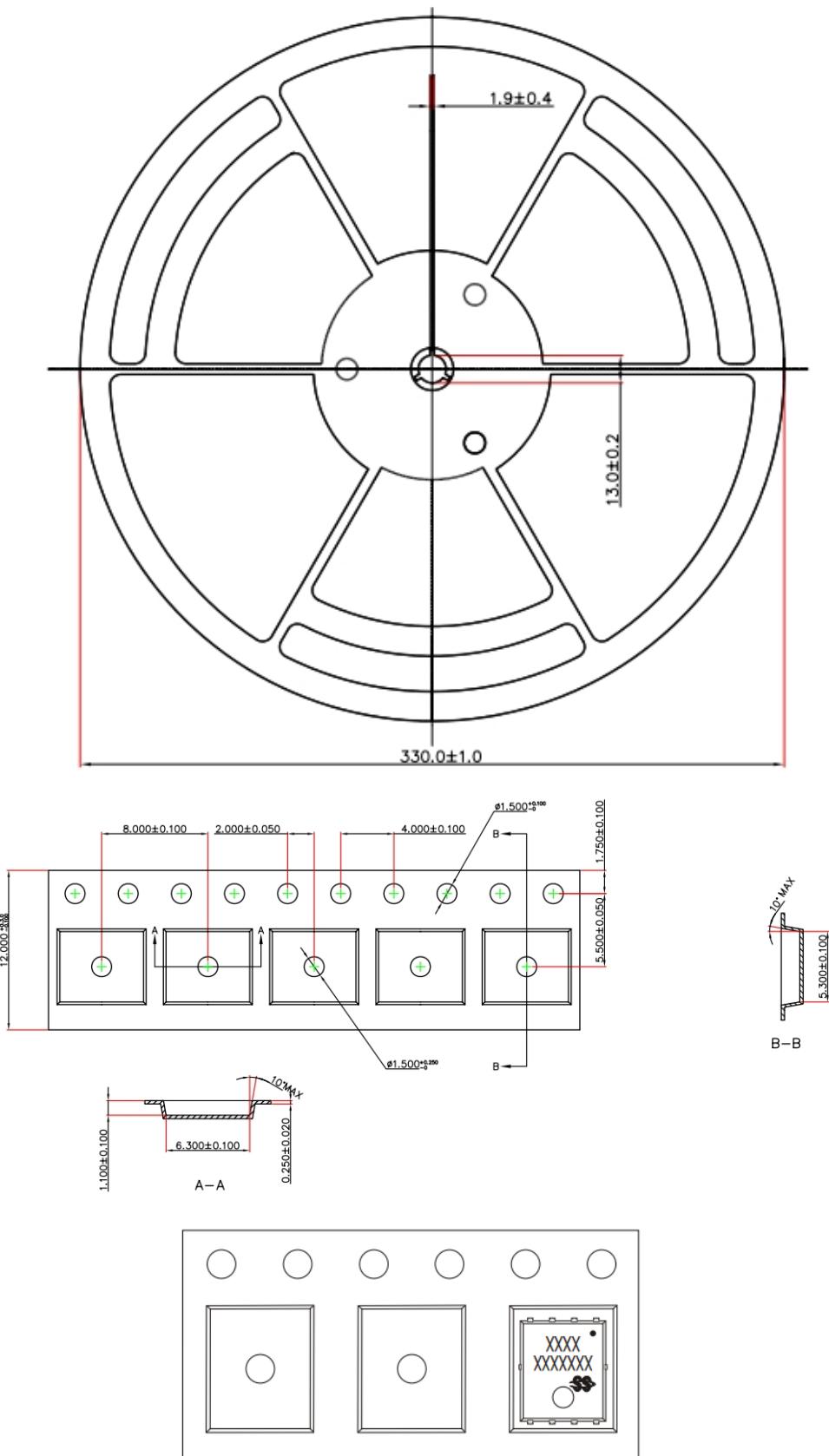
➤ Package Information



Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF		0.010REF	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP		0.050TYP	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

➤ Tape and Reel





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